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QUERY CONTROL FORM		RTIS USE ONLY	
Application No. <u>101090,094</u>	Prepared by <u>NH</u>	Tracking Number <u>05893429</u>	
Examiner-GAU <u>THAI-2827</u>	Date <u>3-9-4</u>	Week Date <u>01/19/04</u>	
	No. of queries <u>1</u>	IFW	

JACKET

a. Serial No.	f. Foreign Priority	k. Print Claim(s)	p. <u>PTO-1449</u>
b. Applicant(s)	g. Disclaimer	l. Print Fig.	q. PTOL-85b
c. Continuing Data	h. Microfiche Appendix	m. Searched Column	r. Abstract
d. PCT	i. Title	n. PTO-270/328	s. Sheets/Figs
e. Domestic Priority	j. Claims Allowed	o. PTO-892	t. Other

SPECIFICATION

- a. Page Missing
- b. Text Continuity
- c. Holes through Data
- d. Other Missing Text
- e. Illegible Text
- f. Duplicate Text
- g. Brief Description
- h. Sequence Listing
- i. Appendix
- j. Amendments
- k. Other

CLAIMS

- a. Claim(s) Missing
- b. Improper Dependency
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- d. Incorrect Numbering
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- f. Punctuation
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MESSAGE

PTO-1449: Please either initial or line through citations. Copy provided for reference.

Thank you

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RESPONSE

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Please type a plus sign (+) inside this box. FORM PTO/SB/08

Substitute for form 1449A/PTO		Complete if Known	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)		Application Number	
		Filing Date	
		First Named Inventor	MAN HON CHENG
		Group Art Unit	
		Examiner Name	
Sheet 2 of 2	Attorney Docket Number	SC11852HP	

JC936 U.S. PTO
10/090094
03/04/02

OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
	3	NATIONAL SEMICONDUCTOR CORPORATION, Semiconductor Packaging Assembly Technology, August 1999	
	4	NATIONAL SEMICONDUCTOR CORPORATION, Plastic Package Moisture-Induced Cracking, August 1999	
	5	RUIHUA HAN, LINHUO SHI, AND MAHESH GUPTA, Three-Dimensional Simulation of Microchip Encapsulation Process, Department of Mechanical Engineering-Engineering Mechanics, Michigan Technological University, Houghton, Michigan 49931	

Examiner Signature	<i>Luan Thai</i>	Date Considered	1/03
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation, if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ Unique citation designation number. ² Applicant is to place a check mark here if English Language Translation is attached.